AN ELLSWORTH ADHESIVES COMPANY

Product Spotlight EPI282

ResinLab® EP1282 is the most versatile and

popular electronic potting and encapsulating compound in ResinLab's product line. Its combination of elongation and toughness enables superior performance under extreme temperature cycling. This semi-rigid polymer absorbs differences in CTE's of various substrates; insulating and protecting the most delicate SMT components.

EP1282 Features & Benefits:

- Both black and clear versions are UL certified with a UL94HB flammability rating at 1.5mm
- Excellent mechanical properties including high modulus, tensile strength and elongation
- Low viscosity, easy to process,
 1:1 mix ratio
- Excellent adhesion with high lap shear strengths to a variety of substrates
- Long pot life with room temperature cure that can be accelerated with heat
- Good electrical insulating properties
- Low exotherm suitable for small to large mass applications

For more information on ResinLab® EP1282, contact



800-888-0698 | info@ellsworth.com

EP1282 is available in:

50ml cartridges 400ml cartridges Gallon kits 5 gallon kits



ified with a high

EP1282 Properties:

Viscosity	Pot Life
Mixed: 3,000 cps @ 1/s	l hour
Hardness	Tensile Strength
70 Shore D	1,600 psi
Modulus	Elongation
10,000 psi	120%
Lap Shear Strength	Cure Time
1,700 psi	I hour@65 ℃

ResinLab LLC · 877-259-1669 · resinlab.com

© Copyright 2019 Ellsworth Corporation. All rights reserved.